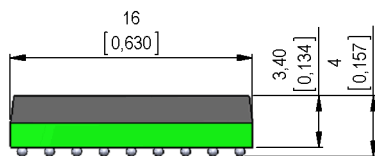


Dimensions mm[inch]

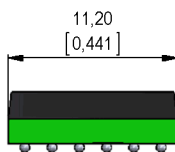
tolerances acc. to DIN ISO 2768-m
Toleranzen gem. DIN ISO 2768-m

Isometric

Scale 1:1
Maßstab 1:1

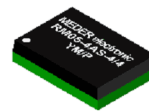


Post reflow hight



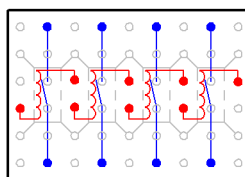
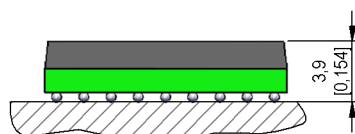
Layout

Top view
Draufsicht



Marking

according to EN60062/factory code
gem. EN60062/Fertigungsstätte



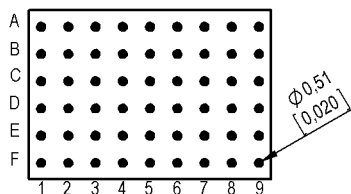
red dots = coil pins
blue dots = switch pins
grey dots = shield pins (all grey pins interconnected)

MEDER electronic
RM05-4AS-4/4
YM/P

Recommended PCB Pad Layout

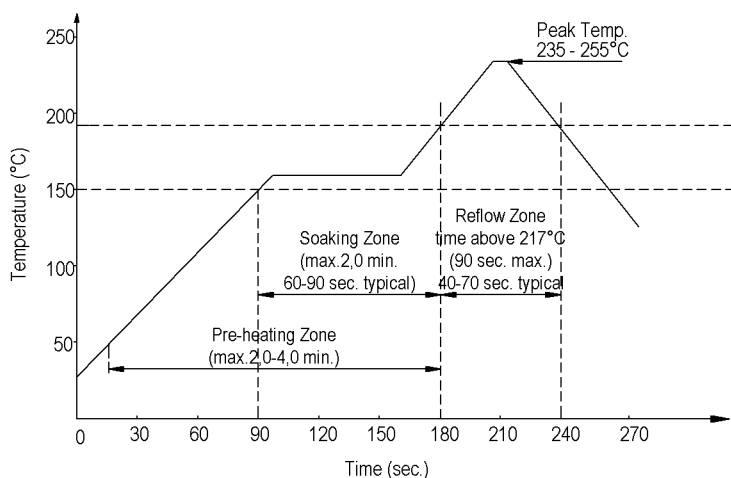
Top view / Draufsicht

Grid Spacing is 1.8mm on center



Recommended lead free reflow profile

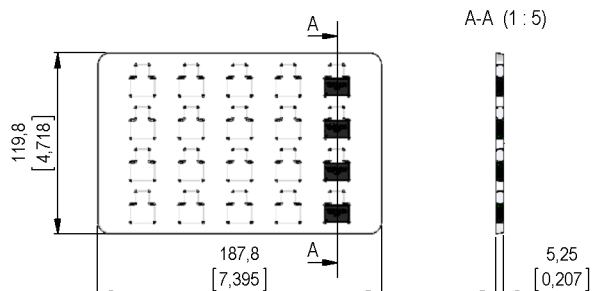
typical reflow profile for RM series for usage with
Sn96,5 Ag3 Cu0,5



HF - Parameter

See webpage www.meder.com or ask
your responsible Customer Service
Einzu sehen unter www.meder.com oder kontaktieren
Sie den verantwortlichen Vertriebsmitarbeiter

Relay packaging orientation



Coil Data at 20 °C	Conditions	Min	Typ	Max	Unit
Coil resistance		166	185	204	Ohm
Coil voltage			5		VDC
Rated power			135		mW
Pull-In voltage				3,75	VDC
Drop-Out voltage		0,5			VDC

RF Characteristics	Conditions	Min	Typ	Max	Unit
S-Parameters		Available upon request			

Contact data 80	Conditions	Min	Typ	Max	Unit
Contact-No.		80			
Contact-form		A			
Contact-material		Rhodium			
Contact-rating	Any DC combination of V & A not to exceed their individual max.'s			10	W
Switching voltage	DC or Peak AC			170	V
Switching current	DC or Peak AC			0,5	A
Carry current	DC or Peak AC			0,5	A
Contact resistance static	Measured with 40% overdrive Start Value			200	mOhm
Insulation resistance	RH <45 %, 100 V test voltage	1	10		GOhm
Breakdown voltage	according to EN 60255-5	210			VDC
Operate time incl. bounce	measured with 40% overdrive			0,6	ms
Release time	measured with no coil excitation			0,1	ms
Capacitance	@ 10 kHz above open switch		0,2		pF

Special Product Data	Conditions	Min	Typ	Max	Unit
Number of contacts		4			
Isolation voltage Coil/Contact	according to EN 60255-5	1,5			kV DC
Insulation resistance Coil/Contact	RH <45%, 200 VDC measuring voltage	10			TOhm
Capacity Coil/Contact	@ 10 kHz		0,7		pF
Case color		black			
Sealing compound		Thermoset Molding Compound			
Material connection pads		BGA solderballs D=0,025 inches, Pb free			
Reach / RoHS conformity		yes			
Magnetic Shield		yes			

Environmental data	Conditions	Min	Typ	Max	Unit
Shock	1/2 sine wave duration 11ms			50	g
Vibration	from 10 - 2000 Hz			20	g
Operating temperature		-40		85	°C
Storage temperature		-55		125	°C
Reflow Soldering Temperature				260	°C
Washability		fully sealed			

General data	Conditions	Min	Typ	Max	Unit
Packaging		4 x 5 Blister packaged			